

DATA SHEET

74LVT1403

**3.3V combined 8-bit bus receiver and
4-bit bus driver**

Product specification

1998 Nov 12

IC23 Data Handbook

3.3V combined 8-bit bus receiver and 4-bit bus driver

74LVT1403

FEATURES

- 4-bit 74LVT125-like bus driver
- 8-bit 74LVT14-like Schmitt trigger
- Bus drive +64mA/-32mA
- 7 bus inputs with common inversion control pin
- 32-pin TSSOP footprint
- DE pin with resistive pull up and active LOW for easier live insertion
- DE pin includes Schmitt trigger with typical 0.6V hysteresis

DESCRIPTION

The 74LVT1403 is a high-performance BiCMOS product designed for V_{CC} operation at 3.3V.

This device combines the functionality of a 4-bit data path bus driver and 8-bit Schmitt trigger bus receiver, along with control logic in one 32-pin package.

The receiver inputs are Schmitt trigger type capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. The receiver outputs are 74LVT14 style with +32mA/-20mA drive capability. The receiver inputs include the bus hold feature.

The driver outputs feature power-up in 3-State/live insertion capability and are all controlled by the A/B, EN1, and EN2 control pins. The driver inputs include the bus hold feature.

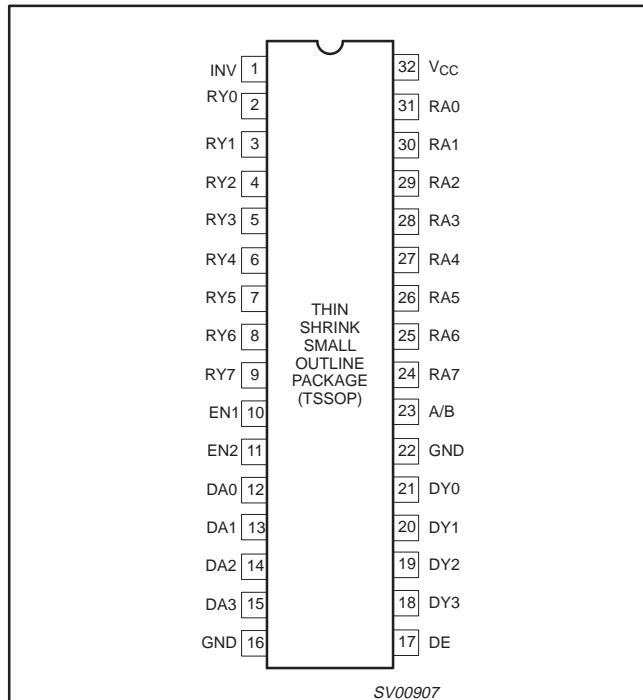
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^\circ\text{C}$; $GND = 0\text{V}$	TYPICAL	UNIT
t_{PLH}	Propagation delay A_n to Y_n	$C_L = 50\text{pF}$; $V_{CC} = 3.3\text{V}$	4.5	ns
t_{PHL}	Propagation delay A_n to Y_n	$C_L = 50\text{pF}$; $V_{CC} = 3.3\text{V}$	4.0	ns
C_{IN}	Input capacitance	$V_I = 0\text{V}$ or 3.0V	3	pF
I_{CC}	Total supply current	Outputs low, $V_{CC} = 3.6\text{V}$	4	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
32-pin plastic TSSOP	-40°C to +85°C	74LVT1403 DR	74LVT1403 DR	SOT487-1

PIN CONFIGURATION



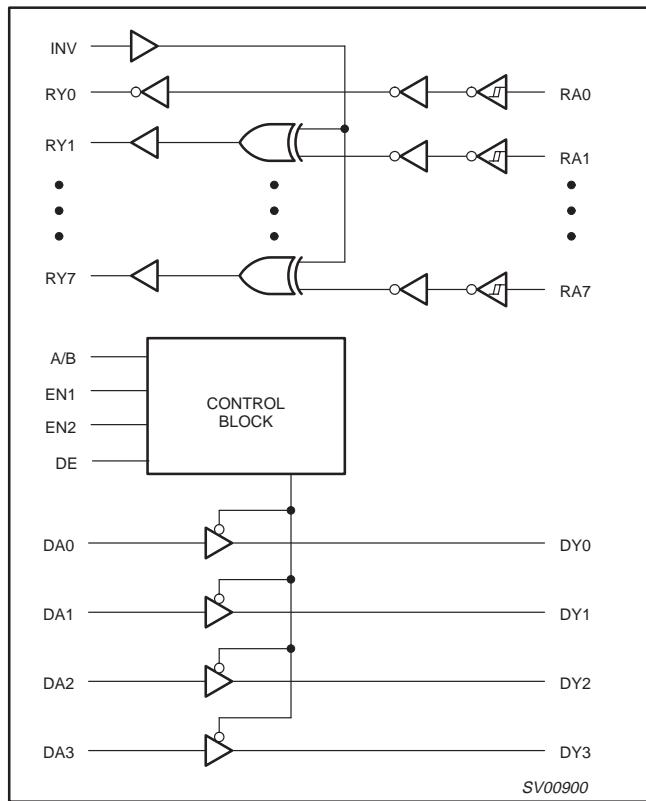
PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
31, 30, 29, 28, 27, 26, 25, 24	RA0–RA7	Receive Data inputs
2, 3, 4, 5, 6, 7, 8, 9	RY0–RY7	Receive Data outputs
12, 13, 14, 15	DA0–DA3	Driver Data inputs
21, 20, 19, 18	DY0–DY3	Driver Data outputs
10, 11	EN1, EN2	Driver Output enables
23	A/B	Mode control for enables
1	INV	Inversion control
16, 22	GND	Ground (0V)
32	V_{CC}	Positive supply voltage
17	DE	Driver output enable active LOW with resistive pull up

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LOGIC SYMBOL



FUNCTION TABLE – RECEIVER

INPUTS		OUTPUTS	
RA0-RA7	INV	RY0	RY1-RY7
L	X	H	—
H	X	L	—
L	L	—	L
H	L	—	H
L	H	—	H
H	H	—	L

H = High voltage level

L = Low voltage level

X = Don't care

— = Reported on different line

FUNCTION TABLE – DRIVER

CONTROL INPUTS				OUTPUT CONDITION
DE	A/B	EN1	EN2	DY Status
L	L	L	L	A
L	L	X	H	Z
L	L	H	X	Z
L	H	H	H	A
L	H	X	L	Z
L	H	L	X	Z
H	X	X	X	Z

H = High voltage level

L = Low voltage level

X = Don't care

Z = High impedance "off" state

A = Active

DATA PATH IN ACTIVE MODE

INPUT	OUTPUT
DAn	DYn
L	L
H	H

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		−0.5 to +4.6	V
V_I	DC input voltage ³		−0.5 to +7.0	V
V_{OUT}	DC output voltage ³	Output in Off or High state	−0.5 to +7.0	V
I_{OUT}	DY _n DC output current	Output in Low state	128	mA
		Output in High state	−64	mA
	RY _n DC output current	Output in Low state	−32	mA
		Output in High state	64	mA
I_{IK}	DC input diode current	$V_I < 0$	−50	mA
I_{OK}	DC output diode current	$V_O < 0$	−50	mA
T_{stg}	Storage temperature range		−65 to +150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
V_{CC}	DC supply voltage	2.7	3.6	V
V_I	Input voltage	0	5.5	V
V_{IH}	High-level input voltage	2.0		V
V_{IL}	Low-level Input voltage		0.8	V
I_{OH}	High-level output current	DY _n	−32	mA
		RY _n	−20	mA
I_{OL}	Low-level output current	DY _n	32	mA
		RY _n	32	mA
Low-level output current; current duty cycle $\leq 50\%$, $f \geq 1\text{kHz}$		DY _n	64	mA
$\Delta t/\Delta V$	Input transition rise or fall rate; Outputs enabled		10	ns/V
T_{amb}	Operating free-air temperature range	−40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT		
			Temp = -40°C to +85°C		MIN	TYP ¹		
			MIN	TYP ¹				
V_{T+}	Positive-going threshold	RAn	$V_{CC} = 3.3V$		1.5	1.7	2.0	V
V_{T-}	Negative-going threshold	RAn	$V_{CC} = 3.3V$		0.9	1.1	1.3	V
ΔV_T	Hysteresis	RAn	$V_{CC} = 3.3V$		0.4	0.6		V
V_{IK}	Input clamp voltage		$V_{CC} = 2.7V$; $I_{IK} = -18mA$				-1.2	V
V_{OH}	High-level output voltage	RYn	$V_{CC} = 2.7$ to $3.6V$; $I_{OH} = -100\mu A$	$V_{CC}-0.2$				V
			$V_{CC} = 2.7V$; $I_{OH} = -6mA$	2.4				V
			$V_{CC} = 3.0V$; $I_{OH} = -20mA$	2.0				V
		DYN	$V_{CC} = 2.7$ to $3.6V$; $I_{OH} = -100\mu A$	$V_{CC}-0.2$	$V_{CC}-0.1$			V
			$V_{CC} = 2.7V$; $I_{OH} = -8mA$	2.4	2.5			V
			$V_{CC} = 3.0V$; $I_{OH} = -32mA$	2.0	2.2			V
V_{OL}	Low-level output voltage	RYn	$V_{CC} = 2.7V$; $I_{OL} = 100\mu A$			0.2	V	
			$V_{CC} = 2.7V$; $I_{OL} = 24mA$			0.5	V	
			$V_{CC} = 3.0V$; $I_{OL} = 32mA$			0.5	V	
		DYN	$V_{CC} = 2.7V$; $I_{OL} = 100\mu A$		0.1	0.2	V	
			$V_{CC} = 2.7V$; $I_{OL} = 24mA$		0.3	0.5	V	
			$V_{CC} = 3.0V$; $I_{OL} = 16mA$		0.25	0.4	V	
			$V_{CC} = 3.0V$; $I_{OL} = 32mA$		0.3	0.5	V	
			$V_{CC} = 3.0V$; $I_{OL} = 64mA$		0.4	0.55	V	
			$V_{CC} = 0$ or $3.6V$; $V_I = 5.5V$	All inputs	1	10	μA	
			$V_{CC} = 3.6V$; $V_I = V_{CC}$	Control pins	± 0.1	± 1		
I_I	Input leakage current		$V_{CC} = 3.6V$; $V_I = GND$	INV, EN1, EN2, A/B	± 0.1	± 1		
				DE	-60	-100		
		Data port ⁴	$V_{CC} = 3.6V$; $V_I = V_{CC}$		0.1	1		
			$V_{CC} = 3.6V$; $V_I = GND$		-1	-5		
I_{OFF}	Output off current		$V_{CC} = 0V$; V_I or $V_O = 0$ to $4.5V$		1	± 100	μA	
I_{HOLD}	Bus hold current RA and DA inputs		$V_{CC} = 3V$; $V_I = 0.8V$	75	150		μA	
			$V_{CC} = 3V$; $V_I = 2.0V$	-75	-150		μA	
I_{EX}	Current into an output in the High state when $V_O > V_{CC}$		$V_O = 5.5V$; $V_{CC} = 3.0V$		60	125	μA	
$I_{PU/PD}$	Power-up/down 3-State output current ³		$V_{CC} \leq 1.2V$; $V_O = 0.5V$ to V_{CC} ; $V_I = GND$ or V_{CC} ; EN1, EN2, A/B, DE = Don't care		± 1	± 100	μA	
I_{OZH}	3-State output high current		$V_{CC} = 3.6V$; $V_O = 3.0V$		1	5	μA	
I_{OZL}	3-State output low current		$V_{CC} = 3.6V$; $V_O = 0.5V$		-1	-5	μA	
I_{CCH}	Quiescent supply current		$V_{CC} = 3.6V$; Outputs High, $V_I = GND$ or V_{CC} , $I_O = 0$		0.13	0.19	mA	
I_{CCL}			$V_{CC} = 3.6V$; Outputs Low, $V_I = GND$ or V_{CC} , $I_O = 0$		4	11	mA	
I_{CCZ}			$V_{CC} = 3.6V$; Outputs Disabled, $V_I = GND$ or V_{CC} , $I_O = 0$ ⁵		0.13	0.19	mA	
ΔI_{CC}	Additional supply current per input pin ²		$V_{CC} = 3V$ to $3.6V$; One input at $V_{CC}-0.6V$, Other inputs at V_{CC} or GND		0.1	0.2	mA	

NOTES:

1. All typical values are at $V_{CC} = 3.3V$ and $T_{amb} = 25^\circ C$.
2. This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.
3. This parameter is valid for any V_{CC} between 0V and 1.2V with a transition time of up to 10msec. From $V_{CC} = 1.2V$ to $V_{CC} = 3.3V \pm 0.3V$, a transition time of 100 μ sec is permitted. This parameter is valid for $T_{amb} = 25^\circ C$ only.
4. Unused pins at V_{CC} or GND.
5. All RYn outputs High. All DYN outputs pulled up to V_{CC} or pulled down to ground.

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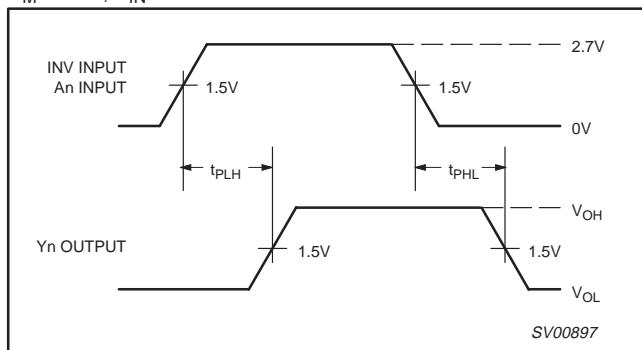
AC CHARACTERISTICS

RAn = Receive inputs; RYn = Receive outputs
DAn = Driver inputs; Dyn = Driver outputs

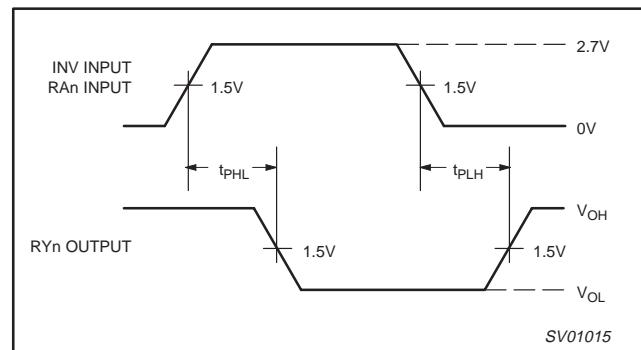
SYMBOL	PARAMETER	WAVEFORM	LIMITS				UNIT	
			$V_{CC} = 3.3V \pm 0.3V$		$V_{CC} = 2.7V$	MAX		
			MIN	TYP	MAX			
t_{PLH} t_{PHL}	Propagation delay RA0 to RY0	2	1.0 1.0	3.8 3.2	5.7 4.4	6.9 4.3	ns	
t_{PLH} t_{PHL}	Propagation delay RAn to RYn (n = 1 to 7)	1, 2	2.0 2.0	4.5 4.0	6.7 5.7	7.8 6.4	ns	
t_{PLH} t_{PHL}	Propagation delay Invert to RYn	1, 2	2.0 2.0	4.0 3.6	6.3 5.5	7.1 7.4	ns	
t_{PLH} t_{PHL}	Propagation delay DAn to DYn	1	1.0 1.0	3.1 2.0	4.2 3.0	4.7 3.5	ns	
t_{PZH} t_{PZL}	Output enable time ENn to DYn with A/B = 0	3	2.0 2.0	4.8 4.3	7.1 6.7	9.6 7.4	ns	
t_{PZH} t_{PZL}	Output enable time ENn to DYn with A/B = 1	4	2.0 2.0	4.3 4.0	6.5 6.1	7.8 6.6	ns	
t_{PHZ} t_{PLZ}	Output disable time ENn to DYn with A/B = 0	3	2.0 2.0	4.7 4.0	7.1 6.3	8.2 6.9	ns	
t_{PHZ} t_{PLZ}	Output disable time ENn to DYn with A/B = 1	4	2.0 2.0	4.2 4.0	6.8 6.2	8.3 6.5	ns	
t_{PZH} t_{PZL}	Output enable time A/B to DYn	3, 4	2.0 2.0	5.0 4.2	8.6 6.5	9.5 7.2	ns	
t_{PHZ} t_{PLZ}	Output disable time A/B to DYn	3, 4	2.0 2.0	5.1 4.3	7.5 6.2	7.7 6.6	ns	
t_{PZH} t_{PZL}	Output enable time DE to DYn	3	2.0 2.0	5.1 4.7	7.6 6.8	9.1 7.5	ns	
t_{PHZ} t_{PLZ}	Output disable time DE to DYn	3	2.0 2.0	5.9 4.9	9.3 7.2	9.7 7.7	ns	

AC WAVEFORMS

$V_M = 1.5V$, $V_{IN} = GND$ to $2.7V$



Waveform 1. Input (An) to Output (Yn) Propagation Delays



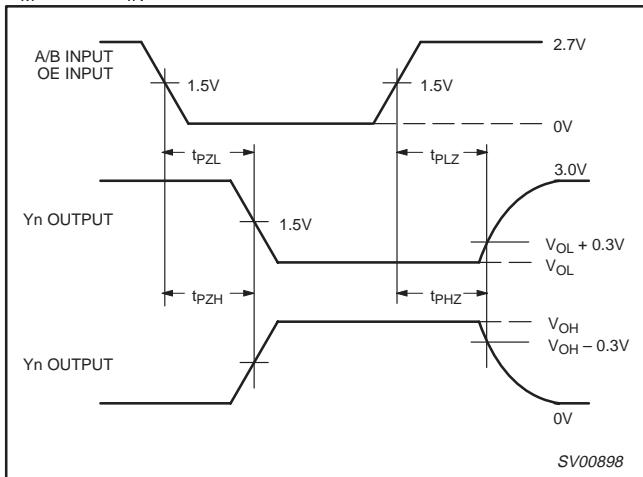
Waveform 2. Input (An) to Output (Yn) Propagation Delays

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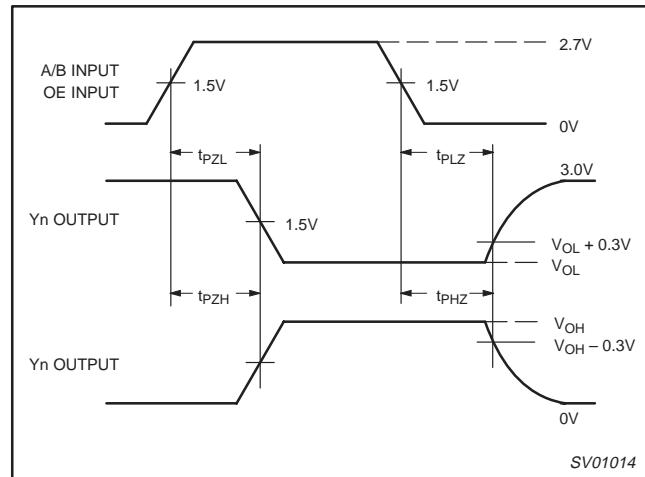
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AC WAVEFORMS (Continued)

$V_M = 1.5V$, $V_{IN} = GND$ to $2.7V$

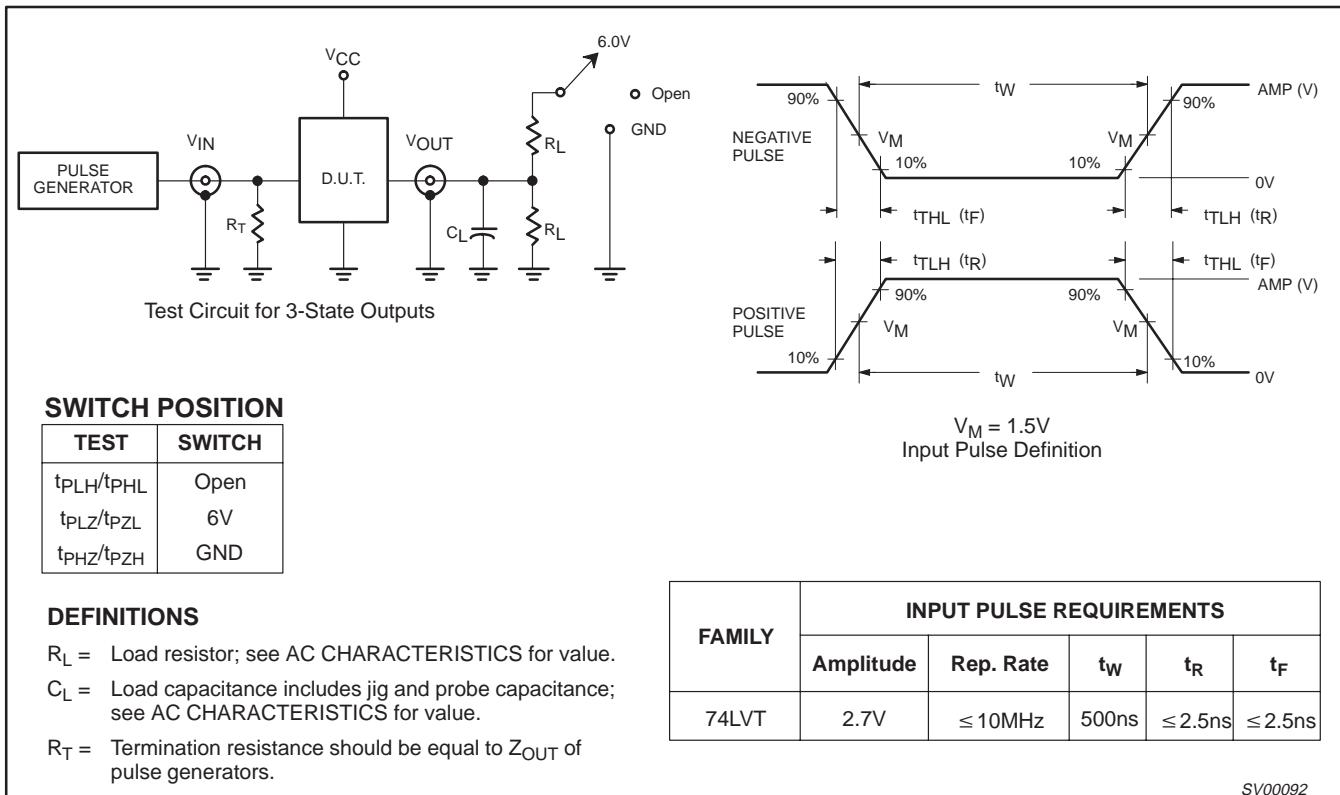


Waveform 3. 3-State Output Enable and Disable Times



Waveform 4. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORM

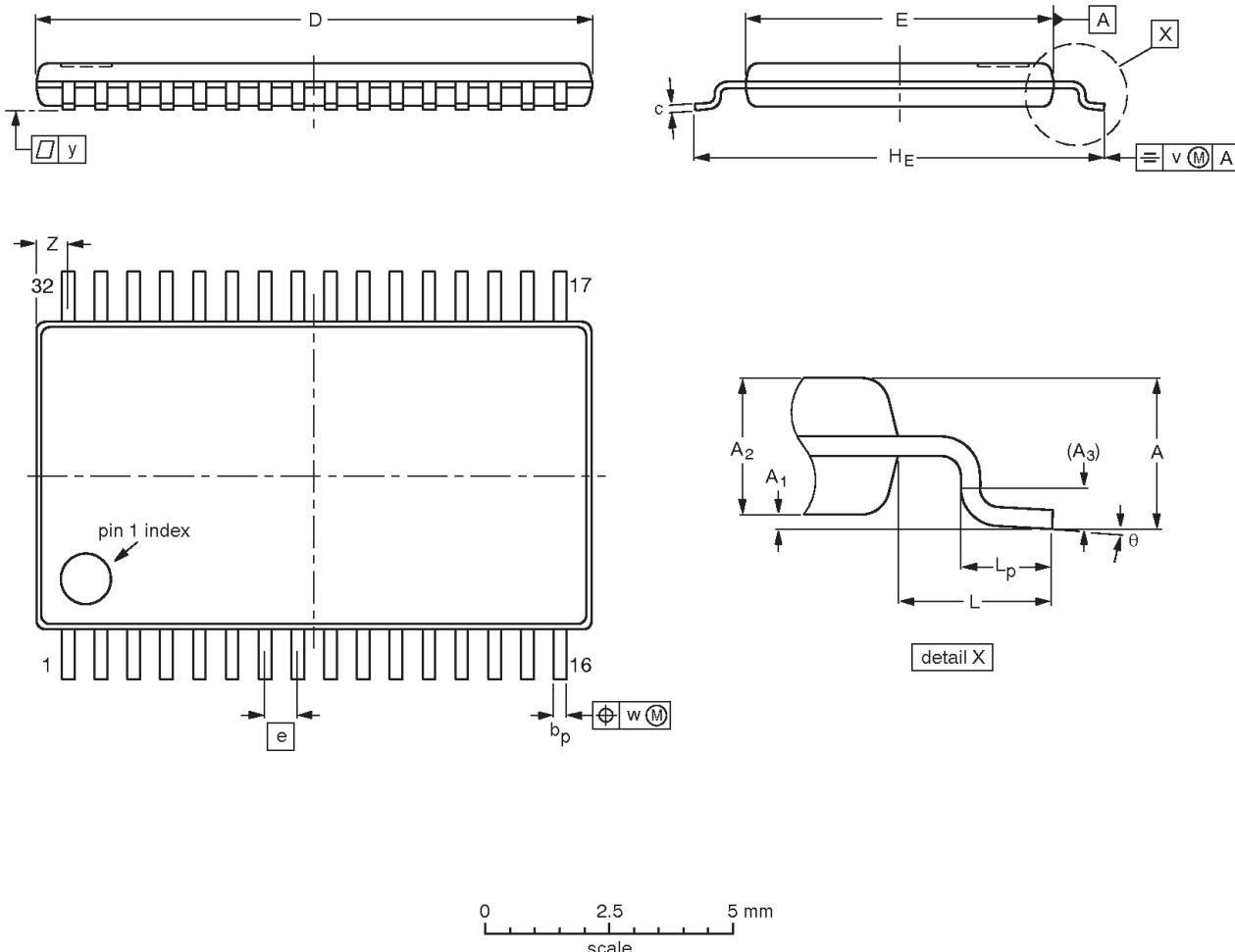


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TSSOP32: plastic thin shrink small outline package; 32 leads;
body width 6.1 mm; lead pitch 0.65 mm

SOT487-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	v	w	y	z	θ
mm	1.10 0.05	0.15 0.85	0.95	0.25	0.30 0.19	0.20 0.09	11.10 10.90	6.20 6.00	0.65	8.30 7.90	1.00	0.75 0.50	0.20	0.10	0.10	0.78 0.48	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT487-1		MO-153				97-06-11

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Philips Semiconductors
811 East Arques Avenue
P.O. Box 3409
Sunnyvale, California 94088-3409
Telephone 800-234-7381

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